

MP0115



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Inventor: Sutardja, Sehat

Group Art Unit: 2826

Serial No.: 09/966,914

Examiner: Williams,
Alexander O.

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Title: Improved Integrated Chip Package Having Intermediate Substrate

CERTIFICATE OF MAILING

I hereby certify that this correspondence, and the documents attached hereto, are being deposited with the United States Postal Service as First Class mail in an envelope addressed to Assistant Commissioner for Patents, Washington, D.C. 20231 on this date.

Date: July 7, 2003

ASSOCIATE POWER OF ATTORNEY

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Please recognize as Associate Attorney in this case:

Joseph L. Stevenson

Registration No. 43,163

Please direct all correspondence relating to this application to:

Eric B. Janofsky
General Patent Counsel
Marvell Semiconductor, Inc.
700 First Avenue, Mail Stop 509
Sunnyvale, CA 94089
General Telephone Number (408) 222-2500
Facsimile (408) 752-9034
Email: janofsky@marvell.com

Signature of Principal Attorney of Record

Eric B. Janofsky
Reg. No. 30,759

Date: 7/7/03

Form Letters 1



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